



April 13, 2005

PCN Number: 0503

PCN Change Level: Major

Subject: Addition of Assembly Site for Standard (Sn/Pb) Lead-Finish PQFP Packages

Dear Purchasing,

This notice is to inform you that Actel will be adding Amkor as an assembly location for the devices listed below. Depending on device/package type, this location is in addition to STATSChipPAC, Singapore. The assembly location country ("Singapore if manufactured at STATSChipPAC, and "Korea" if manufactured at Amkor) is marked on the bottom of the device.

Device	Package
APA1000	PQ208
APA750	PQ208
APA600	PQ208
APA450	PQ208
APA300	PQ208
APA150	PQ208
APA075	PQ208

This qualification summary also qualifies Sumitomo G700 series "green" mold compound.

Actel will begin shipping units from Amkor 90 days after the date of this letter. The assembly site has been qualified (Qualification Summary # PA-060).

If there are any questions please contact Actel's Corporate Applications Engineering at tech@actel.com.

Regards,

Actel Corporation